



Product Change Notification

Change Notification #: 117642 - 01
Change Title: Select Intel® SSD 660p Series Products, PCN 117642-01, Product Design, Label, Order Code
Firmware and Label Updates
Removal of select SKUs, not currently affected by Firmware and Product Label Change
Date of Publication: June 24, 2020

Key Characteristics of the Change:

Product Design, Label, Order Code

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	July 6, 2020
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Description of Change to the Customer:

Reason for Revision: Removal of select SKUs, not currently affected by Firmware and Product Label Change

- **Select MM#'s: 999CG3, 999CG4, 976802, 976803, 976804 are not currently affected by this firmware and label change update and have been removed from this PCN, the changes for these MM#'s will happen in a future date.**

The Intel® SSD 660p Series SKUs listed in the Products Affected table below will have the firmware version updated from 002C to 004C. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.

The product labels will be updated with new SA numbers as well as the new firmware version number:

512 GB Current

 **INTEL® SSD 660p SERIES**
SN PHNH-0203XXXX512A
EUI64: XXXXXXXXXXXXXXXX
Made in XXXXX RATED DC 3.3V 1.35
www.intel.com

Model: SSDPEKNW512GB
SA: J93121-101
PBA: J63240-100
WARRANTY VOID IF REMOVED

DJID: XXXXXXXXXXXXXXXX
XXXXXXXXXXXXXXXXXXXX
LBA 1,000,215,216

FW: 002C
512GB

intel
PCI EXPRESS nvm
033025 RoHS
CAN ICES-3(B)/NMB-3(B)
UL US E139761
VCCI
CE
KC
M5IP-REM-CPU-M2PCIE
SSS
Recycling symbol
e

512 GB New

 **INTEL® SSD 660p SERIES**
SN PHNH-0203XXXX512A
EUI64: XXXXXXXXXXXXXXXX
Made in XXXXX RATED DC 3.3V 1.35
www.intel.com

Model: SSDPEKNW512GB
SA: K10634-102
PBA: J63240-100
WARRANTY VOID IF REMOVED

DJID: XXXXXXXXXXXXXXXX
XXXXXXXXXXXXXXXXXXXX
LBA 1,000,215,216

FW: 004C
512GB

intel
PCI EXPRESS nvm
033025 RoHS
CAN ICES-3(B)/NMB-3(B)
UL US E139761
VCCI
CE
KC
M5IP-REM-CPU-M2PCIE
SSS
Recycling symbol
e

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	Pre Change MM#	Pre Change TA	Pre Change SA	Post Change MM#	Post Change TA	Post Change SA
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW512G8X1	978348	K10628-101	K10634-101		K10628-102	K10634-102
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW512G8XT	978349	K10629-101	K10634-101		K10629-102	K10634-102
Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW010T8X1	978350	K10631-101	K10635-101		K10631-102	K10635-102
Intel® SSD 660p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW020T8X1	978351	K10633-101	K10636-101		K10633-102	K10636-102
Intel® SSD 660p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW020T8XT	984872	K31002-101	K10636-101		K31002-102	K10636-102
Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW010T8XT	984875	K31001-101	K10635-101		K31001-102	K10635-102
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic 100 Pack	SSDPEKNW512G8	999CG3	K42147-100	J93121-101	999M0M	K64735-101	K10635-102
Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic 100 Pack	SSDPEKNW010T8	999CG4	K42149-100	J93130-101	999M5H	K64739-101	K10635-102
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic Single Pack	SSDPEKNW512G801	976802	J93118-101	J93121-101	999M5F	K64738-101	K10635-102
Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic Single Pack	SSDPEKNW010T801	976803	J93119-101	J93130-101	999M0V	K64736-101	K10635-102
Intel® SSD 660p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic Single Pack	SSDPEKNW020T801	976804	J93120-101	J93132-101	976804	J93120-102	K10636-102

PCN Revision History:

Date of Revision:

June 19, 2020

June 24, 2020

Revision Number:

00

01

Reason:

Originally Published PCN

Removal of select SKUs, not currently affected by Firmware and Product Label Change



Product Change Notification

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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